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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Hall et al.

Serial No.: 10/785,122

Filed: February 24, 2004

For: UNDERFILLED, ENCAPSULATED
SEMICONDUCTOR DIE ASSEMBLIES
AND METHODS OF FABRICATION

Confirmation No.: 1653

Examiner: J. Diaz

Group Art Unit: 2815

Attorney Docket No.: 2269-5165.1US
(01-0947.01/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

January 12, 2005
Date

Signature

Joseph A. Walkowski
Name (Type/Print)

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In compliance with the duty to disclose information material to patentability pursuant to 37 C.F.R. § 1.56, it is respectfully requested that this Supplemental Information Disclosure Statement be entered and the documents listed on attached Form PTO/SB/08 be considered by the Examiner and made of record. Copies of U.S. patents are not being provided pursuant to M.P.E.P. 609 III A(2). The listed documents were cited by the Office in co-pending application Serial No. 10/191,655, filed on July 8, 2002, and directed to a related invention.

Serial No.: 10/785,122

In accordance with 37 C.F.R. § 1.97(g) and (h), filing of this Supplemental Information Disclosure Statement is not to be construed as a representation that a search has been made or an admission that the information cited herein is, or is considered to be, material to patentability as defined in 37 C.F.R. § 1.56(b). Further, no representation is made by Applicants herein that no other possible material information as defined in 37 C.F.R. § 1.56 (b) exists.

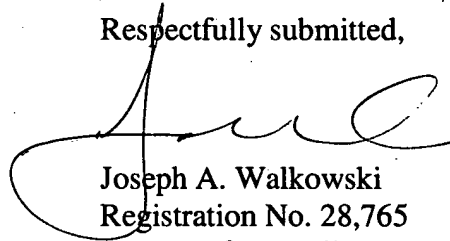
U.S. Patent Documents

<u>U.S. Patent No.</u>	<u>Publication Date</u>	<u>Patentee</u>
US - 4,048,670	09/13/1977	Eysermans
US - 5,561,329	10/01/1996	Mine et al.
US - 6,229,202 B1	05/08/2001	Corisis
US - 6,519,846 B2	02/18/2003	Park et al.
US - 6,700,210 B1	03/02/2004	Smith

Applicants offer to supply any explanation or discussion of the documents which the Examiner feels is necessary or desirable and which is requested.

This Supplemental Information Disclosure Statement is filed before the mailing date of a first Office Action on the merits, and therefore no fee is due.

Respectfully submitted,



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Enclosures: Form PTO/SB/08
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